

## 3.0A Low-Dropout Linear Regulator with Programmable Soft-Start

### FEATURES

- 3.0A LDO Regulator with Programmable Soft-Start (SS)
- SS Pin Provides a Linear Startup with Ramp Time Set by External Capacitor
- Supports Input Voltages as Low as 0.9V
- Adjustable Output (0.8V to 3.3V)
- Ultra-Low Dropout: 120mV at 3.0A (typ)
- 1% Accuracy Over Line, Load, and Temperature
- Stable with Any or No Output Capacitor
- Active High Enable
- Open-Drain Power-Good (5 × 5 QFN)
- Available in 5mm × 5mm × 1mm QFN and DDPAK-7 Packages
- External BIAS Permits Low  $V_{IN}$  Operation with Excellent Transient Response

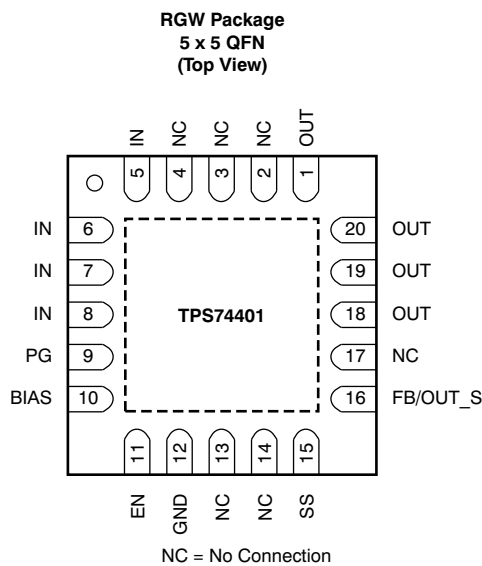
### APPLICATIONS

- FPGA Applications
- DSP Core and I/O Voltages
- Post-Regulation Applications
- Applications with Special Start-up time Requirements

### DESCRIPTION

The TPS74401 low dropout (LDO) linear regulator provides an easy-to-use power management solution for many high-current applications. The user-programmed soft-start (SS) input limits inrush current in FPGAs and DSPs. The enable input (EN) and power-good (PG) outputs allow easy sequencing with external regulators. This complete flexibility permits the user to configure a solution that will meet the sequencing requirements of FPGAs, DSPs, and other applications with special startup requirements.

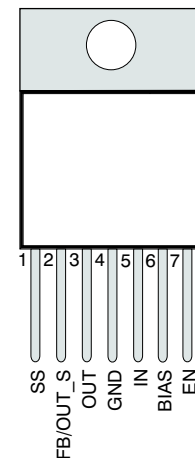
A precision reference and error amplifier deliver 1% accuracy over load, line, temperature, and process. The LDO regulator is stable with any or no output capacitor and is fully specified from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ . The TPS74401 is offered in a small 5mm × 5mm QFN package, yielding a highly compact total solution size. For applications that require additional power dissipation, the DDPAK (KTW) package is also available.



Actual Size



**KTW Package**  
DDPAK-7  
(Top View)



PRODUCT PREVIEW



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

**ORDERING INFORMATION<sup>(1)</sup>**

| PRODUCT  | V <sub>OUT</sub> <sup>(2)</sup> | PACKAGE-LEAD             | ORDERING NUMBER |
|----------|---------------------------------|--------------------------|-----------------|
| TPS74401 | Adjustable                      | 5 × 5 QFN <sup>(3)</sup> | TPS74401RGWT    |
|          |                                 |                          | TPS74401RGWR    |
| TPS74401 | Adjustable                      | DDPAK-7 <sup>(4)</sup>   | TPS74401KTWT    |
|          |                                 |                          | TPS74401KTWR    |

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Other output voltages are available, minimum order quantities may apply. See available output voltage options table for details; contact factory for availability.
- (3) The T suffix indicates 250-piece tape and reel; the R suffix indicates 3000-piece tape and reel quantities.
- (4) The T suffix indicates 50-piece tape and reel; the R suffix indicates 500-piece tape and reel quantities.

**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

At T<sub>A</sub> = –40°C to +125°C, unless otherwise noted. All voltages are with respect to GND.

|   | TPS74401  | UNIT |
|---|---|------|
| V <sub>IN</sub> , V <sub>BIAS</sub> Input voltage range | –0.3 to +6  | V    |
| V <sub>EN</sub> Enable voltage range                    | –0.3 to +6 or V <sub>IN</sub> + 0.3, whichever is greater | V    |
| V <sub>PG</sub> Power-good voltage range                | –0.3 to +6  | V    |
| V <sub>OUT</sub> Output voltage range                   | –0.3 to V <sub>IN</sub>                                   | V    |
| I <sub>OUT</sub> Maximum output current                 | Internally limited  |      |
| Output short circuit duration                           | Indefinite  |      |
| P <sub>DISS</sub> Continuous total power dissipation    | See Dissipation Ratings                                   |      |
| T <sub>J</sub> Operating junction temperature range     | –40 to +150   | °C   |
| T <sub>STG</sub> Storage junction temperature range     | –55 to +150   | °C   |
| ESD rating, HBM   | 2   | kV   |
| ESD rating, CDM   | 500   | V    |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**DISSIPATION RATINGS**

| PACKAGE     | θ <sub>JA</sub> | θ <sub>JC</sub> | T <sub>A</sub> < +25°C<br>POWER RATING | DERATING FACTOR<br>ABOVE T <sub>A</sub> = +25°C |
|-------------|-----------------|-----------------|--|---|
| RGW (QFN)   | 31.4°C/W        | 1.25°C/W        | 3.183W                                 | 0.0318W/°C                                      |
| KTW (DDPAK) | TBD             | TBD             | TBD                                    | TBD   |

PRODUCT PREVIEW

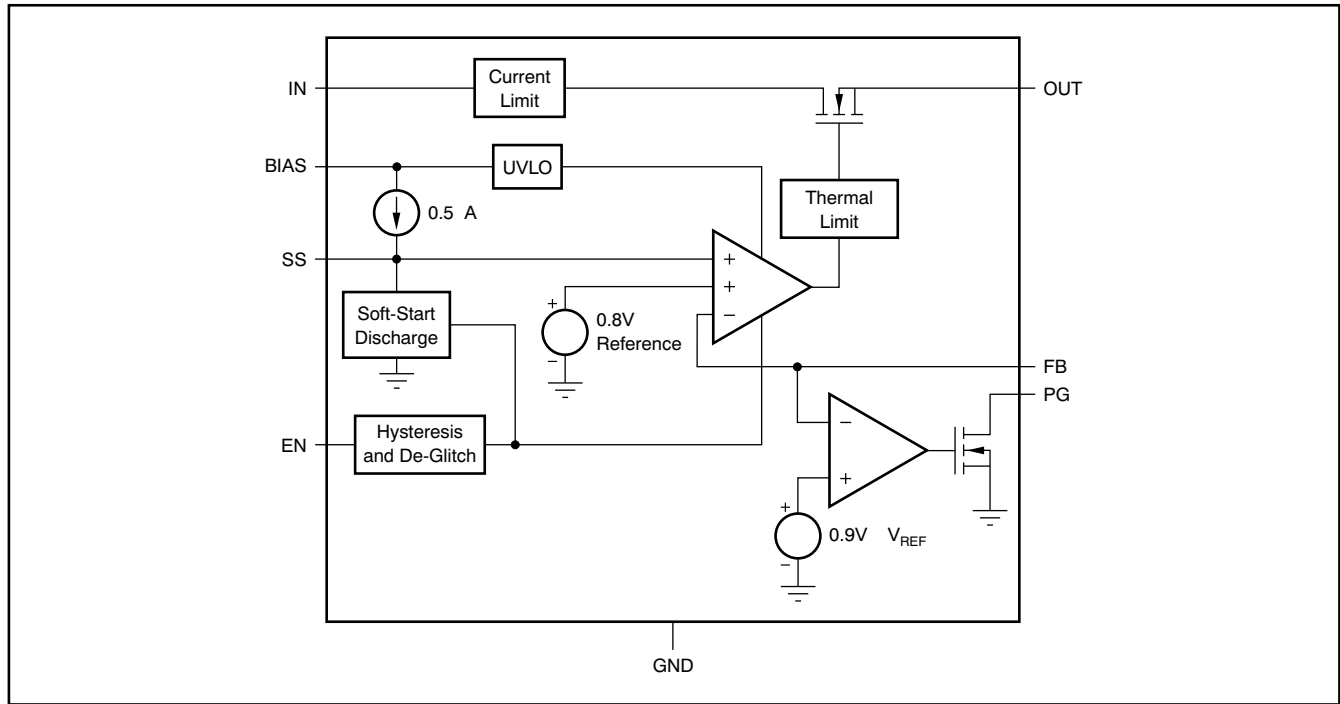
**ELECTRICAL CHARACTERISTICS**

 At  $T_A = +25^\circ\text{C}$ ,  $V_{EN} = 1.1\text{V}$ ,  $V_{IN} = V_{OUT} + 0.3\text{V}$ ,  $C_{IN} = C_{BIAS} = 0.1\mu\text{F}$ ,  $C_{OUT} = 10\mu\text{F}$ ,  $I_{OUT} = 50\text{mA}$ ,  $V_{BIAS} = 3.3\text{V}$ , and  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ , unless otherwise noted.

| PARAMETER         |  | TEST CONDITIONS   | TPS74401                     |                     |            | UNIT                |
|-------------------|--|---|------------------------------|---------------------|------------|---------------------|
|                   |  |   | MIN                          | TYP                 | MAX        |                     |
| $V_{IN}$          | Input Voltage Range                                |   | $V_{OUT(NOM)} + V_{DO(MAX)}$ |                     | 5.5        | V                   |
| $V_{REF}$         | Internal Reference (Adj.)                          |   | 0.796                        | 0.8                 | 0.804      | V                   |
| $V_{BIAS}$        | Bias Pin Voltage Range <sup>(1)</sup>              |   | 2.375                        |                     | 5.5        | V                   |
| $V_{OUT}$         | Output Voltage Range                               | $V_{IN} = V_{OUT} + 1\text{V}$ , $I_{OUT} = 1.5\text{A}$ , $V_{BIAS} = 5\text{V}$   | $V_{REF}$                    |                     | 3.3        | V                   |
|                   | Accuracy   | Nominal, $T_J = +25^\circ\text{C}$  | -0.5                         |                     | +0.5       | %                   |
|                   |  | $2.97\text{V} \leq V_{BIAS} \leq 5.5\text{V}$ , $50\text{mA} \leq I_{OUT} \leq 3.0\text{A}$   | -1                           | $\pm 0.5$           | 1          |                     |
| $V_{OUT}/V_{IN}$  | Line Regulation                                    | $V_{OUT(NOM)} + 0.3 < V_{IN} < 5.5\text{V}$   |                              | TBD                 | TBD        | %/V                 |
| $V_{OUT}/I_{OUT}$ | Load Regulation                                    | $50\text{mA} \leq I_{OUT} \leq 3.0\text{A}$   |                              | TBD                 | TBD        | %/A                 |
| $V_{DO}$          | Dropout Voltage (External Bias)                    | $I_{OUT} = 3.0\text{A}$ , $V_{BIAS} - V_{OUT(NOM)} \geq 1.62\text{V}$ , QFN   |                              | 120                 | 200        | mV                  |
|                   |  | $I_{OUT} = 3.0\text{A}$ , $V_{BIAS} - V_{OUT(NOM)} \geq 1.62\text{V}$ , DDPAK   |                              | 150                 | 240        | mV                  |
|                   | Dropout Voltage ( $V_{IN} = V_{BIAS}$ )            | $I_{OUT} = 3.0\text{A}$   |                              |                     | 1.6        | V                   |
| $I_{BIAS}$        | Bias Pin Current                                   | $I_{OUT} = 0\text{mA}$ to $3.0\text{A}$   |                              | 3                   | 5          | mA                  |
| $I_{SHDN}$        | Shutdown Supply Current (IN)                       | $V_{EN} \leq 0.4\text{V}$ , $T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$  |                              | 50                  | 100        | $\mu\text{A}$       |
| $I_{CL1}$         | Current Limit                                      | $V_{OUT} = 90\% \times V_{OUT(NOM)}$  | 4.1                          |                     | 5.5        | A                   |
| $I_{FB}$          | Feedback Pin Current                               |   |                              | 10                  | 200        | nA                  |
| PSRR              | Power-Supply Rejection ( $V_{IN}$ to $V_{OUT}$ )   | 1kHz, $I_{OUT} = 3.0\text{A}$ , $V_{IN} = 1.8\text{V}$ , $V_{OUT} = 1.5\text{V}$ , $V_{BIAS} = 3.3\text{V}$ , $C_{OUT} = 10\mu\text{F}$   |                              | 60                  |            | dB                  |
|                   |  | 300kHz, $I_{OUT} = 3.0\text{A}$ , $V_{IN} = 1.8\text{V}$ , $V_{OUT} = 1.5\text{V}$ , $V_{BIAS} = 3.3\text{V}$ , $C_{OUT} = 10\mu\text{F}$ |                              | 30                  |            |                     |
|                   | Power-Supply Rejection ( $V_{BIAS}$ to $V_{OUT}$ ) | 1kHz, $I_{OUT} = 3.0\text{A}$ , $V_{IN} = 1.8\text{V}$ , $V_{OUT} = 1.5\text{V}$ , $V_{BIAS} = 3.3\text{V}$ , $C_{OUT} = 10\mu\text{F}$   |                              | 50                  |            | dB                  |
|                   |  | 300kHz, $I_{OUT} = 3.0\text{A}$ , $V_{IN} = 1.8\text{V}$ , $V_{OUT} = 1.5\text{V}$ , $V_{BIAS} = 3.3\text{V}$ , $C_{OUT} = 10\mu\text{F}$ |                              | 30                  |            |                     |
| Noise             | Output Noise Voltage                               | 100Hz to 100kHz, $I_{OUT} = 3.0\text{A}$ , $C_{SS} = 0.001\mu\text{F}$  |                              | $25 \times V_{OUT}$ |            | $\mu\text{V}_{RMS}$ |
| $t_{STR}$         | Minimum Startup Time                               | $I_{OUT} = 3.0\text{A}$ , $C_{SS} = \text{Open}$  |                              | 100                 |            | $\mu\text{s}$       |
| $I_{SS}$          | Soft-Start Charging Current                        | $V_{SS} = 0.4\text{V}$  | 0.3                          | 0.5                 | 1          | $\mu\text{A}$       |
| $V_{EN, HI}$      | Enable Input High Level                            |   | 1.1                          |                     | $V_{BIAS}$ | V                   |
| $V_{EN, LO}$      | Enable Input Low Level                             |   | 0                            |                     | 0.4        | V                   |
| $V_{ENHYS}$       | Enable Pin Hysteresis                              |   |                              | 50                  |            | mV                  |
| $V_{ENDG}$        | Enable Pin De-Glitch Time                          |   |                              | 20                  |            | $\mu\text{s}$       |
| $I_{EN}$          | Enable Pin Current                                 | $V_{EN} = 5\text{V}$  |                              | 0.1                 | 1.0        | $\mu\text{A}$       |
| $V_{IT}$          | PG Trip Threshold                                  | $V_{OUT}$ Decreasing  | 88                           | 90                  | 92         | $\%V_{OUT}$         |
| $V_{HYS}$         | PG Trip Hysteresis                                 |   |                              | 3                   |            | $\%V_{OUT}$         |
| $V_{PG, LO}$      | PG Output Low Voltage                              | $I_{PG} = 1\text{mA}$ (sinking), $V_{OUT} < V_{IT}$ , $2.375\text{V} \leq V_{BIAS} \leq 5.5\text{V}$                                      |                              |                     | 0.3        | V                   |
| $I_{PG, LKG}$     | PG Leakage Current                                 | $V_{PG} = 5\text{V}$ , $V_{OUT} > V_{IT}$   |                              | 0.1                 | 1.0        | $\mu\text{A}$       |
| $T_J$             | Operating Junction Temperature                     |   | -40                          |                     | +125       | $^\circ\text{C}$    |
| $T_{SD}$          | Thermal Shutdown Temperature                       | Shutdown, Temperature Increasing  |                              | +165                |            | $^\circ\text{C}$    |
|                   |  | Reset, Temperature Decreasing   |                              | +140                |            |                     |

 (1) Minimum  $V_{BIAS} = 2.375\text{V}$  or  $V_{OUT} + V_{DO}$ , whichever is greater.

**BLOCK DIAGRAM**



**PIN DESCRIPTIONS**

| NAME    | KTW (DDPAK) | RGW (QFN)       | DESCRIPTION   |
|---------|-------------|-----------------|---|
| IN      | 5           | 5-8             | Unregulated input to the device.  |
| EN      | 7           | 11              | Enable pin. Driving this pin high enables the regulator. Driving this pin low puts the regulator into shutdown mode.  |
| SS      | 1           | 15              | Soft-Start pin. A capacitor connected on this pin to ground will set the startup time.  |
| BIAS    | 6           | 10              | Bias voltage for error amplifier, reference, and internal control circuits.   |
| PG      | NA          | 9               | Power-Good (PG) is an open-drain, active-high output that indicates the status of $V_{OUT}$ . When $V_{OUT}$ exceeds the PG trip threshold, the PG pin goes into a high-impedance state. When $V_{OUT}$ is below this threshold the pin is driven to a low-impedance state. A pull-up resistor from 10kΩ to 1MΩ should be used on this pin, which would allow the PG output to attain voltages higher than $V_{IN}$ . |
| FB      | 2           | 16              | This pin is the feedback connection to an external resistor divider network that sets the output voltage.   |
| OUT     | 3           | 1, 18-20        | Regulated output voltage.   |
| NC      | NA          | 2-4, 13, 14, 17 | No connection. This pin can be left floating or connected to GND to allow better thermal contact to the top-side plane.   |
| PAD/TAB |             |                 | Electrically isolated. Should be soldered to ground plane for heat sinking.   |

PRODUCT PREVIEW

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TPS74401KTWR     | PREVIEW               | DDPAK        | KTW             | 7    |             | TBD                     | Call TI          | Call TI                      |
| TPS74401KTWT     | PREVIEW               | DDPAK        | KTW             | 7    |             | TBD                     | Call TI          | Call TI                      |
| TPS74401RGWR     | PREVIEW               | QFN          | RGW             | 20   |             | TBD                     | Call TI          | Call TI                      |
| TPS74401RGWT     | PREVIEW               | QFN          | RGW             | 20   |             | TBD                     | Call TI          | Call TI                      |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

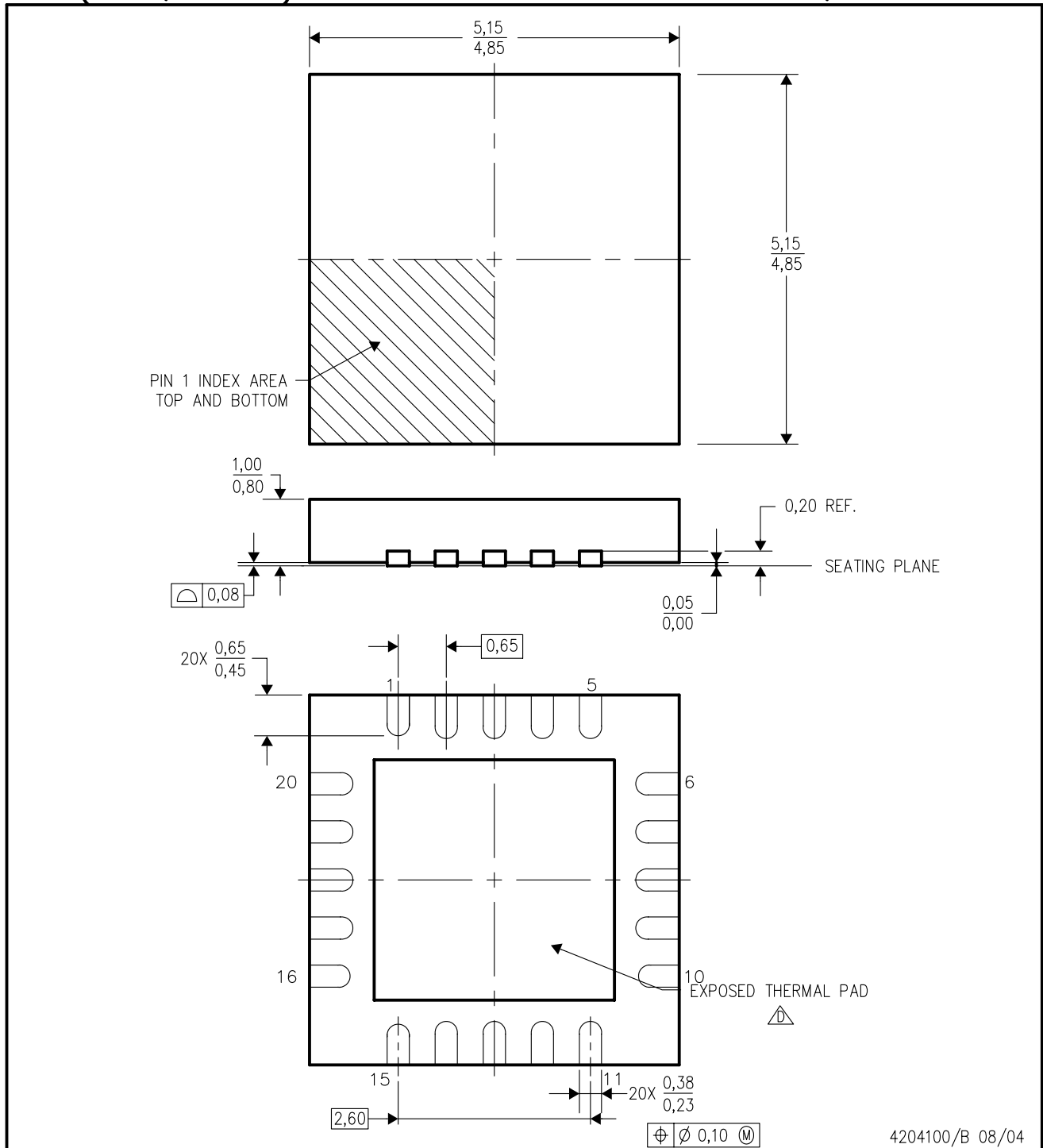
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.


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RGW (S-PQFP-N20)

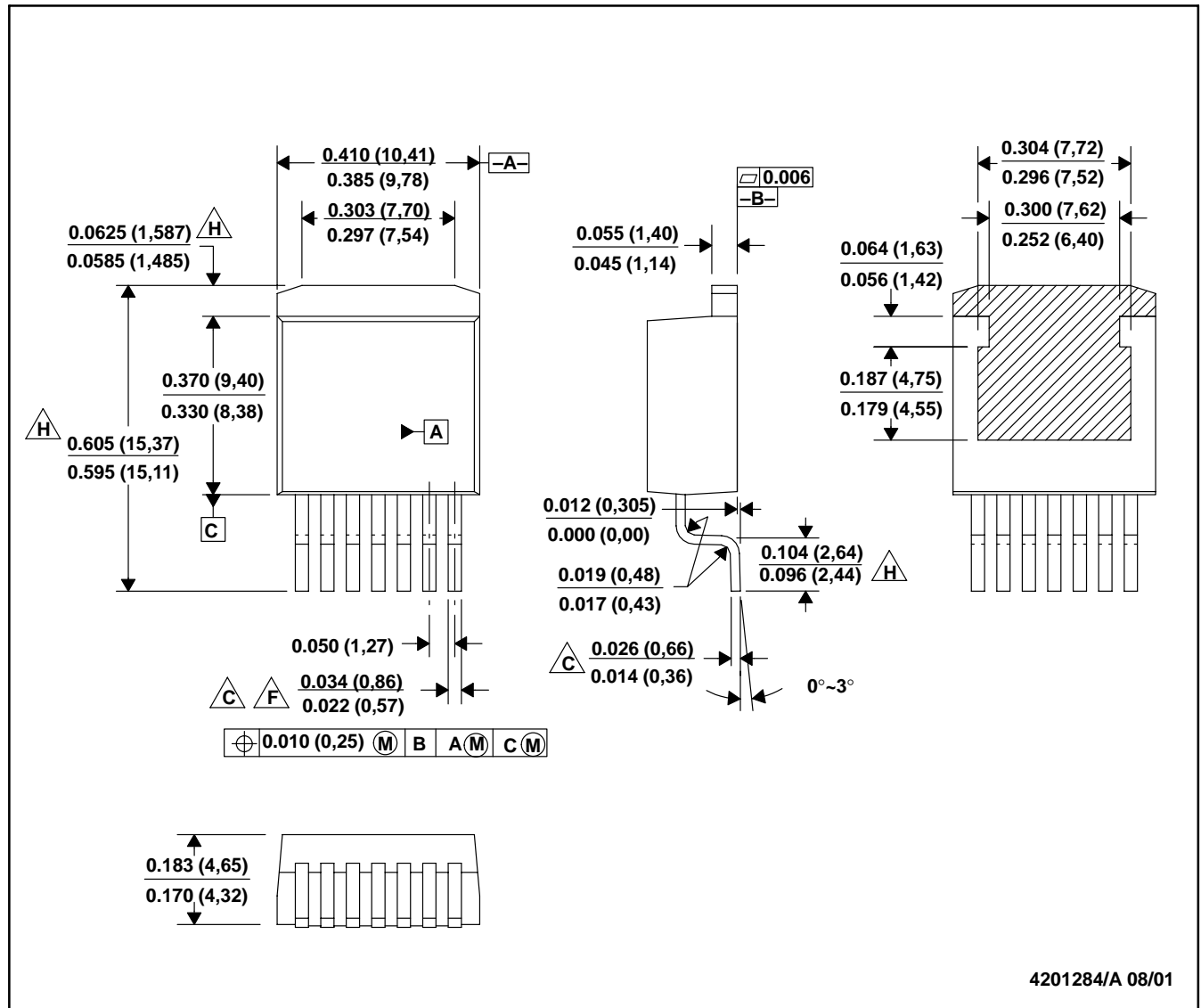
PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5-1994.
  - B. This drawing is subject to change without notice.
  - C. Quad Flat pack, No-leads (QFN) package configuration
  - D.  The package thermal pad must be soldered to the board for thermal and mechanical performance.. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
  - E. Falls within JEDEC MO-220.

## KTW (R-PSFM-G7)

## PLASTIC FLANGE-MOUNT



4201284/A 08/01

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - $\triangle C$ : Lead width and height dimensions apply to the plated lead.
  - Leads are not allowed above the Datum B.
  - Stand-off height is measured from lead tip with reference to Datum B.
  - $\triangle F$ : Lead width dimension does not include dambar protrusion. Allowable dambar protrusion shall not cause the lead width to exceed the maximum dimension by more than 0.003".
  - Cross-hatch indicates exposed metal surface.
  - $\triangle H$ : Falls within JEDEC MO-169 with the exception of the dimensions indicated.

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